

SEMICONDUCTOR TM

#### **General Description:**

The high breakdown voltage, fast switching speed and high forward conductance of this diode packaged in a DO-35 miniature Glass Axial leaded package makes it desirable also as a general purpose diode.

## High Conductance Fast Diode

# 1N4154

## DISCRETE POWER AND SIGNAL TECHNOLOGIES

## Features:

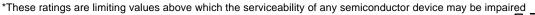
- 500 milliwatt Power Dissipation package.
- Fast Switching Speed,
- Typical capacitance less than 1.0 picofarad.

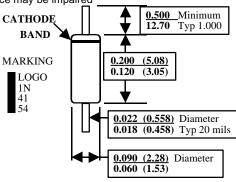
#### **Ordering:**

• 13 inch reel, 50 mm (T50R) & 26 mm (T26R) Tape; 10,000 units per reel.

## **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

Sym	Parameter	Value	Units
T <sub>stg</sub>	Storage Temperature	-65 to +200	OO
TJ	Operating Junction Temperature	175	OO
P <sub>D</sub>	Total Power Dissipation at $T_A = 25^{\circ}C$	500	mW
	Linear Derating Factor from $T_A = 25^{\circ}C$	3.33	mW/ <sup>o</sup> C
R <sub>OJA</sub>	Thermal Resistance Junction-to-Ambient	300	°C/W
W <sub>iv</sub>	Working Inverse Voltage	35	V
I <sub>o</sub>	Average Rectified Current	100	mA
I <sub>F</sub>	DC Forward Current (IF)	300	mA
i <sub>f</sub>	Recurrent Peak Forward Current (IF)	400	mA
i <sub>F(surge)</sub>	Peak Forward Surge Current (IFSM) Pulse Width = 1.0 second	1.0	Amp
	Pulse Width = 1.0 microsecond	4.0	Amp





### **Electrical Characteristics** TA = 25<sup>o</sup>C unless otherwise noted

SYM	CHARACTERISTICS	MIN	МАХ	UNITS	TEST CONDITIONS	
$B_V$	Breakdown Voltage	35		V	$I_{R} = 5.0 \text{ uA}$	
I <sub>R</sub>	Reverse Leakage		100 100	nA uA	$V_{R} = 25 V$ $V_{R} = 25 V, T_{A} = 150^{\circ}C$	
V <sub>F</sub>	Forward Voltage		1.0	V	I <sub>F</sub> = 30 mA	
C <sub>T</sub>	Capacitance		4.0	pF	$V_{R} = 0.0 V, f = 1.0 MHz$	
T <sub>RR</sub>	Reverse Recovery Time		4.0	ns	$I_F = 10 \text{ mA} \text{ V}_R = 6.0 \text{ V}$ $I_{RR} = 1.0 \text{ mA}, R_L = 100 \text{ ohms}$	
© 1997 Fairchild	© 1997 Fairchild Semiconductor Corporation Revision A - September 21, 199					

#### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx<sup>TM</sup> CoolFET<sup>TM</sup> CROSSVOLT<sup>TM</sup> E<sup>2</sup>CMOS<sup>TM</sup> FACT<sup>TM</sup> FACT Quiet Series<sup>TM</sup> FAST<sup>®</sup> FAST<sup>®</sup> FASTr<sup>TM</sup> GTO<sup>TM</sup> HiSeC<sup>TM</sup> ISOPLANAR™ MICROWIRE™ POP™ PowerTrench® QFET™ QS™ Quiet Series™ SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SyncFET™ TinyLogic™ UHC™ VCX™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### **PRODUCT STATUS DEFINITIONS**

**Definition of Terms** 

Datasheet Identification	Product Status	Definition			
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.			
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.			
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.			
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.			